

# STPS1045

## Power Schottky rectifier

## Main product characteristics

I <sub>F(AV)</sub>	10 A
V <sub>RRM</sub>	45 V
V <sub>F</sub>	0.57 V

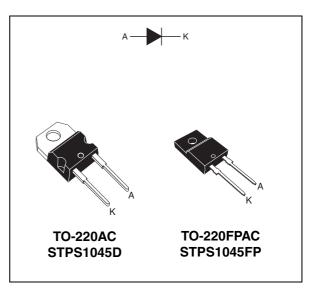
### **Features and Benefits**

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low forward voltage drop
- Insulated package: TO-220FPAC Insulating voltage = 2000V DC Capacitance = 12 pF
- Avalanche capability specified

## Description

Single chip Schottky rectifier suited for Switch Mode Power Supply and high frequency DC to DC converters.

This device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



## 1 Characteristics

Symbol		Value	Unit			
V <sub>RRM</sub>	Repetitive peak revers	se voltage		45	V	
I <sub>F(RMS)</sub>	RMS forward voltage			30	А	
	Average forward TO-220AC		$T_{c} = 150^{\circ} C$	10	Α	
I <sub>F(AV)</sub>	current $\delta = 0.5$	TO-220FPAC	T <sub>c</sub> = 145° C	45° C 10		
I <sub>FSM</sub>	Surge non repetitive for	t <sub>p</sub> = 10 ms sinusoidal	180	Α		
	Repetitive peak reverse current $t_p = 2 \ \mu s$ $F = 1 \ kHz$		t <sub>p</sub> = 2 μs F = 1 kHz	1	A	
P <sub>ARM</sub>	Repetitive peak avalanche power $t_p = 1 \ \mu s \ Tj = 25^{\circ}$ C			4000	W	
T <sub>stg</sub>	Storage temperature range			-65 to + 175	°C	
Тj	Maximum junction temperature			175	°C	
dV/dt	Critical rate of rise of reverse voltage			10000	V/µs	

#### Table 1. Absolute Ratings (limiting values)

#### Table 2. Thermal resistances

Symbol	Parameter		Value	Unit
D	Junction to case	TO-220AC	2.2	°C/W
R <sub>th(j-c)</sub>	Junction to case	TO-220FPAC	4.5	0/11

#### Table 3. Static electrical characteristics

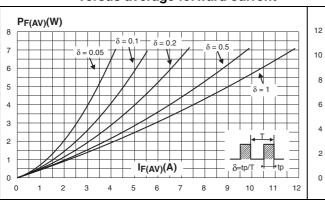
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I <sub>B</sub> <sup>(1)</sup>	Povorso loakago ourropt	$T_j = 25^\circ C$	V - V			100	μA
'R`´	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 125° C	V <sub>R</sub> = V <sub>RRM</sub>			15	mA
		$T_j = 25^\circ C$	I <sub>F</sub> = 20 A			0.84	
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 125° C	I <sub>F</sub> = 20 A			0.72	V	
		T <sub>j</sub> = 125° C	I <sub>F</sub> = 10 A			0.60	

1. Pulse test: tp = 5 ms,  $\delta$  < 2%

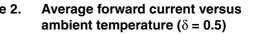
2. Pulse test: tp = 380  $\mu s, \, \delta < 2\%$ 

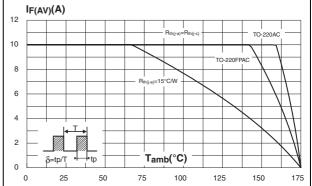
To evaluate the conduction losses use the following equation: P = 0.42 x  $I_{F(AV)}$  + 0.015  ${I_F}^2_{(RMS)}$ 





# Figure 1. Average forward power dissipation Figure 2. versus average forward current





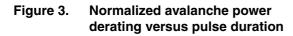


Figure 4. Normalized avalanche power derating versus junction temperature

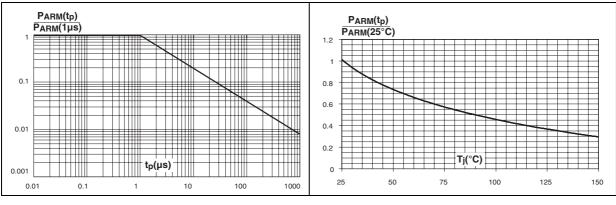
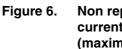
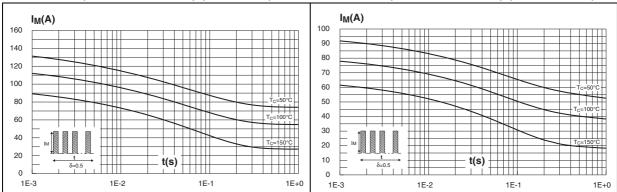


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) (TO-220AC)

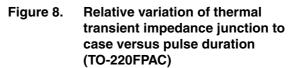


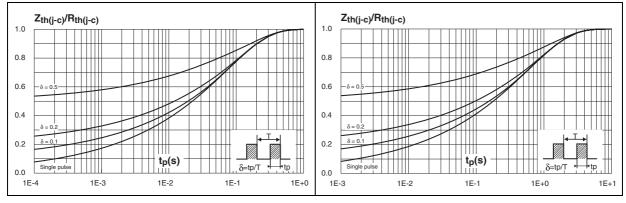
Non repetitive surge peak forward current versus overload duration (maximum values) (TO-220FPAC)



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# Figure 7. Relative variation of thermal transient impedance junction to case versus pulse duration (TO-220AC)





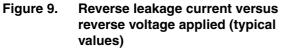


Figure 10. Reverse leakage current versus reverse voltage applied (typical values)

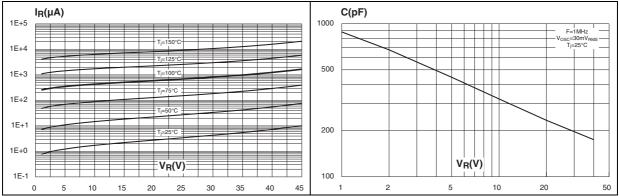
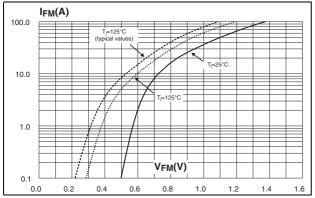


Figure 11. Forward voltage drop versus forward current (maximum values)

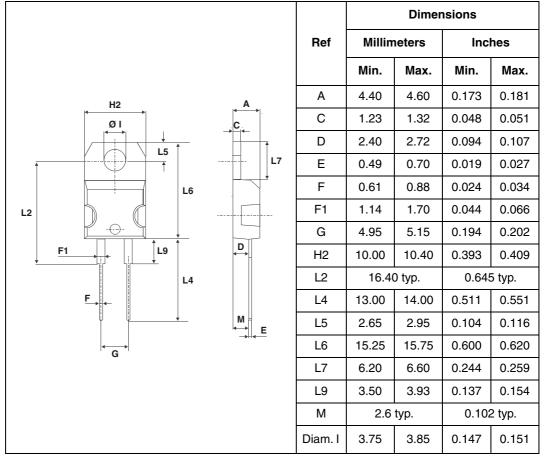




## 2 Package Information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 Nm
- Maximum torque value: 0.70 Nm

#### Figure 12. TO-220AC dimensions



		Dimensions			
	Ref	Millimeters		Inches	
		Min.	Max.	Min.	Max.
	Α	4.4	4.6	0.173	0.181
	В	2.5	2.7	0.098	0.106
	D	2.5	2.75	0.098	0.108
Dia	Е	0.45	0.70	0.018	0.027
	F	0.75	1	0.030	0.039
	F1	1.15	1.70	0.045	0.067
	G	4.95	5.20	0.195	0.205
	G1	2.4	2.7	0.094	0.106
	Н	10	10.4	0.393	0.409
L4	L2	16 Тур.		0.63 Тур.	
	L3	28.6	30.6	1.126	1.205
G1 G1 ↔	L4	9.8	10.6	0.386	0.417
G	L5	2.9	3.6	0.114	0.142
	L6	15.9	16.4	0.626	0.646
	L7	9.00	9.30	0.354	0.366
	Dia.	3.00	3.20	0.118	0.126

Figure 13. TO-220FPAC dimensions

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.



# **3** Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS1045D	STPS1045D	TO-220AC	1.86 g	50	Tube
STPS1045FP	STPS1045FP	TO-220FPAC	1.9 g	50	Tube

# 4 Revision history

Date	Revision	Description of Changes
Jul-2003	5D	Last release.
22-Mar-2007	6	Removed ISOWATT package.



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